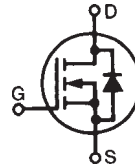


TrenchT2™ GigaMOS™ HyperFET™ Power MOSFET

IXFZ520N075T2

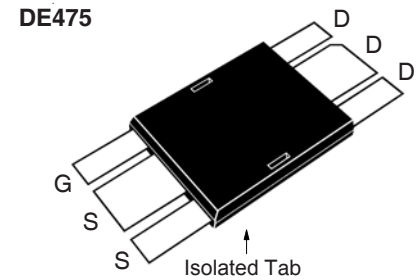
$$\begin{aligned} V_{DSS} &= 75V \\ I_{D25} &= 465A \\ R_{DS(on)} &\leq 1.3m\Omega \end{aligned}$$

(Electrically Isolated Tab)



N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Diode

Symbol	Test Conditions	Maximum Ratings	
V_{DSS}	$T_J = 25^\circ\text{C}$ to 175°C	75	V
V_{DGR}	$T_J = 25^\circ\text{C}$ to 175°C , $R_{GS} = 1M\Omega$	75	V
V_{GSS}	Continuous	± 20	V
V_{GSM}	Transient	± 30	V
I_{D25}	$T_C = 25^\circ\text{C}$	465	A
I_{DM}	$T_C = 25^\circ\text{C}$, Pulse Width Limited by T_{JM}	1560	A
I_A	$T_C = 25^\circ\text{C}$	200	A
E_{AS}	$T_C = 25^\circ\text{C}$	3	J
P_D	$T_C = 25^\circ\text{C}$	600	W
T_J		-55 ... +175	$^\circ\text{C}$
T_{JM}		175	$^\circ\text{C}$
T_{stg}		-55 ... +175	$^\circ\text{C}$
V_{ISOL}	50/60 Hz, RMS $t = 1$ minute $I_{ISOL} \leq 1\text{mA}$ $t = 1$ second	2500 3000	V~ V~
T_L	1.6mm (0.062 in.) from Case for 10s	300	$^\circ\text{C}$
T_{SOLD}	Plastic Body for 10s	260	$^\circ\text{C}$
V_{ISOL}	50/60 Hz, 1 Minute	2500	V~
F_C	Mounting Force	20..120 / 4.5..27	N/lb.
Weight		3	g



G = Gate D = Drain
S = Source

Features

- Silicon Chip on Direct-Copper Bond (DCB) Substrate
- Isolated Substrate
 - Excellent Thermal Transfer
 - Increased Temperature and Power Cycling Capability
 - High Isolation Voltage (2500V~)
- 175°C Operating Temperature
- Very High Current Handling Capability
- Fast Intrinsic Diode
- Avalanche Rated
- Very Low $R_{DS(on)}$

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- DC-DC Converters and Off-Line UPS
- Primary-Side Switch
- High Speed Power Switching Applications

Symbol	Test Conditions	Characteristic Values	
	$(T_J = 25^\circ\text{C}, \text{ Unless Otherwise Specified})$	Min.	Typ.
BV_{DSS}	$V_{GS} = 0V, I_D = 3mA$	75	
$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 8mA$	2.0	4.0
I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$		± 200 nA
I_{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_J = 150^\circ\text{C}$		10 μA 1.5 mA
$R_{DS(on)}$	$V_{GS} = 10V, I_D = 100A, \text{ Note 1}$		1.3 m Ω

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
g_{fs}	$V_{DS} = 10\text{V}$, $I_D = 60\text{A}$, Note 1	95	160	S
C_{iss}	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1\text{MHz}$		41	nF
C_{oss}			4150	pF
C_{rss}			530	pF
R_{GI}	Gate Input Resistance		1.36	Ω
$t_{d(on)}$	Resistive Switching Times $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 200\text{A}$ $R_G = 1\Omega$ (External)		48	ns
t_r			36	ns
$t_{d(off)}$			80	ns
t_f			35	ns
$Q_{g(on)}$	$V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 260\text{A}$		545	nC
Q_{gs}			177	nC
Q_{gd}			135	nC
R_{thJC}				0.25 $^\circ\text{C/W}$
R_{thCS}			0.15	$^\circ\text{C/W}$

Source-Drain Diode

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
I_S	$V_{GS} = 0\text{V}$			520 A
I_{SM}	Repetitive, Pulse Width Limited by T_{JM}			1600 A
V_{SD}	$I_F = 100\text{A}$, $V_{GS} = 0\text{V}$, Note 1			1.25 V
t_{rr}	$I_F = 150\text{A}$, $V_{GS} = 0\text{V}$ $-di/dt = 100\text{A}/\mu\text{s}$ $V_R = 37.5\text{V}$			150 ns
I_{RM}			7	A
Q_{RM}			357	nC

Note 1. Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:	4,835,592	4,931,844	5,049,961	5,237,481	6,162,665	6,404,065 B1	6,683,344	6,727,585	7,005,734 B2	7,157,338B2
	4,850,072	5,017,508	5,063,307	5,381,025	6,259,123 B1	6,534,343	6,710,405 B2	6,759,692	7,063,975 B2	
	4,881,106	5,034,796	5,187,117	5,486,715	6,306,728 B1	6,583,505	6,710,463	6,771,478 B2	7,071,537	

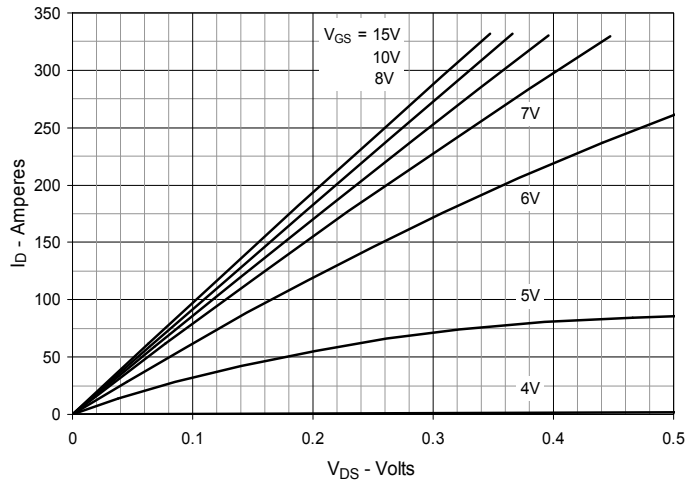
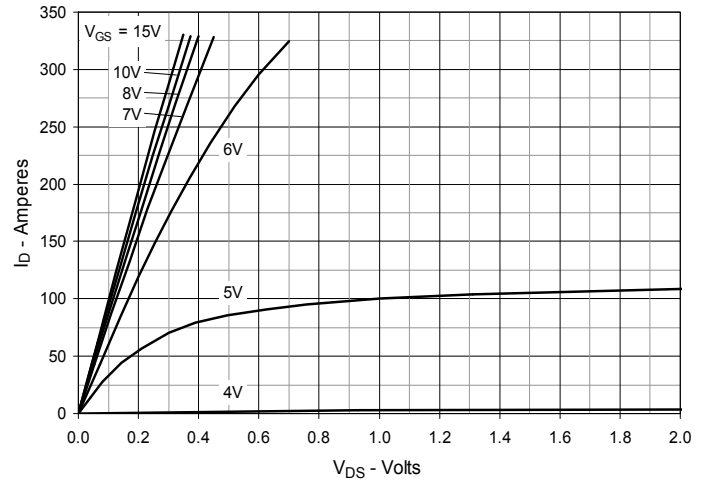
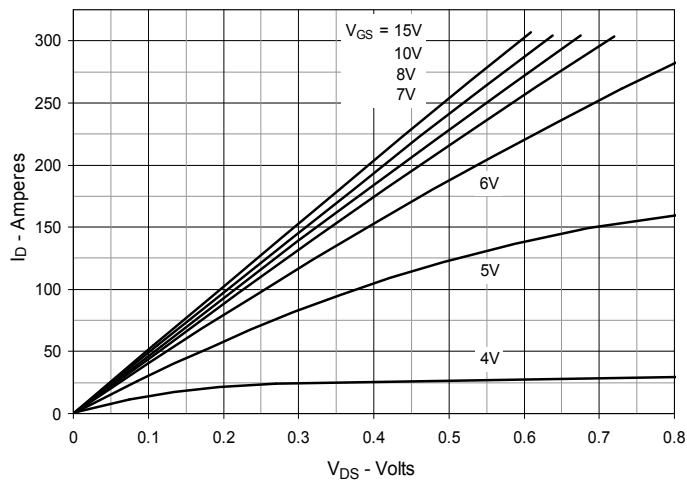
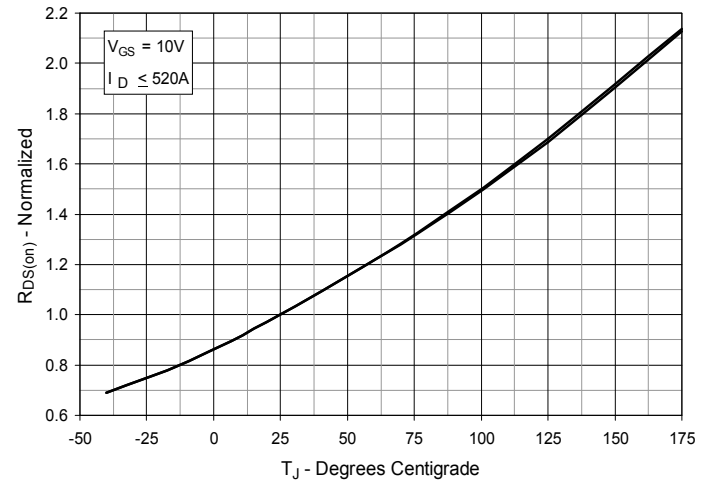
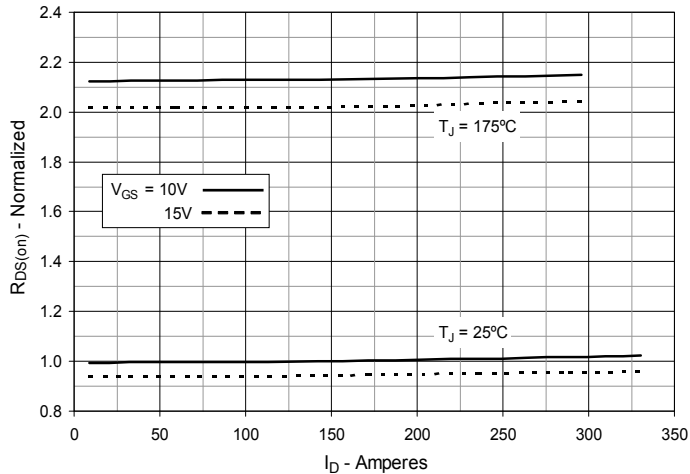
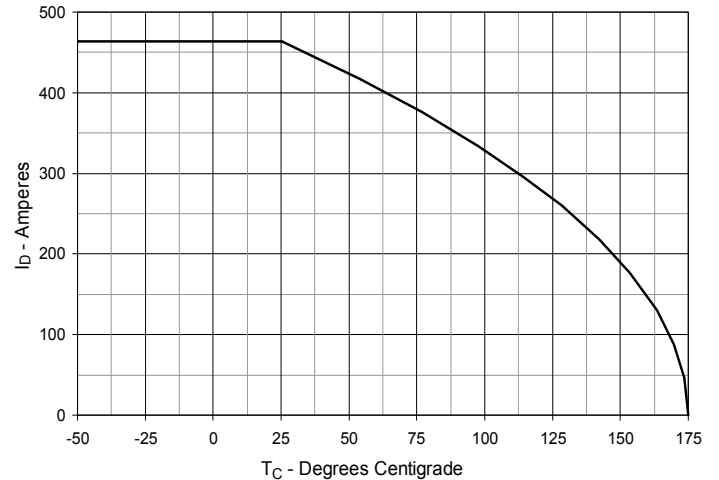
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 3. Output Characteristics @ $T_J = 150^\circ\text{C}$

Fig. 4. Normalized $R_{DS(on)}$ vs. Junction Temperature

Fig. 5. Normalized $R_{DS(on)}$ vs. Drain Current

Fig. 6. Drain Current vs. Case Temperature


Fig. 7. Input Admittance

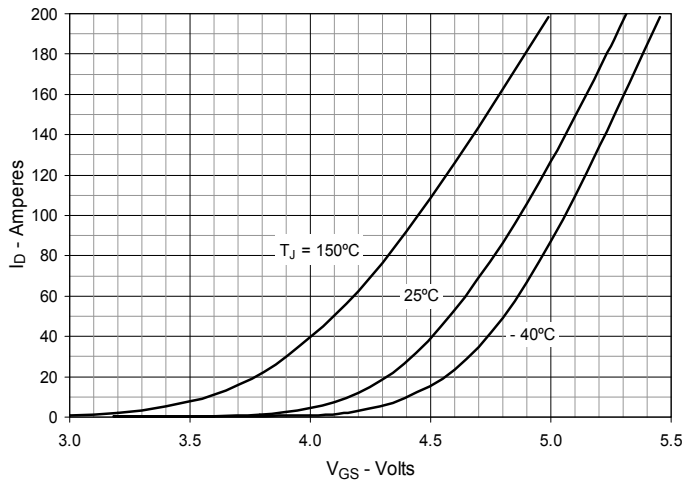


Fig. 8. Transconductance

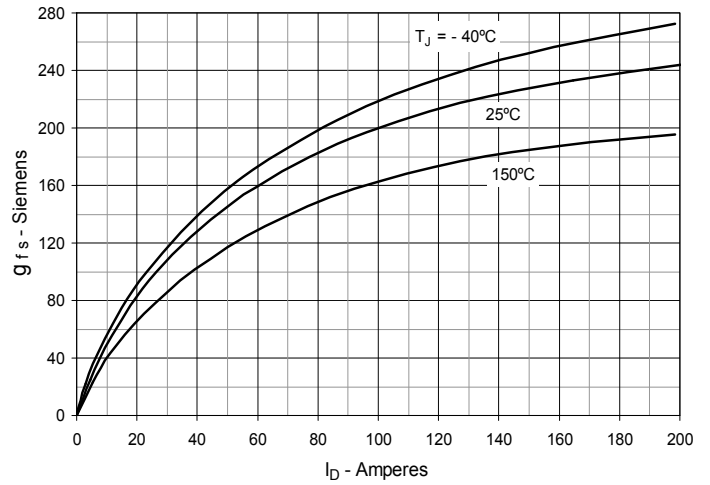


Fig. 9. Forward Voltage Drop of Intrinsic Diode

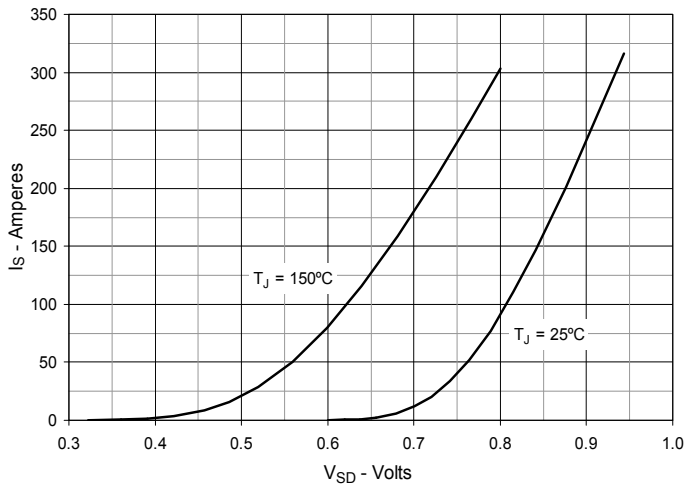


Fig. 10. Gate Charge

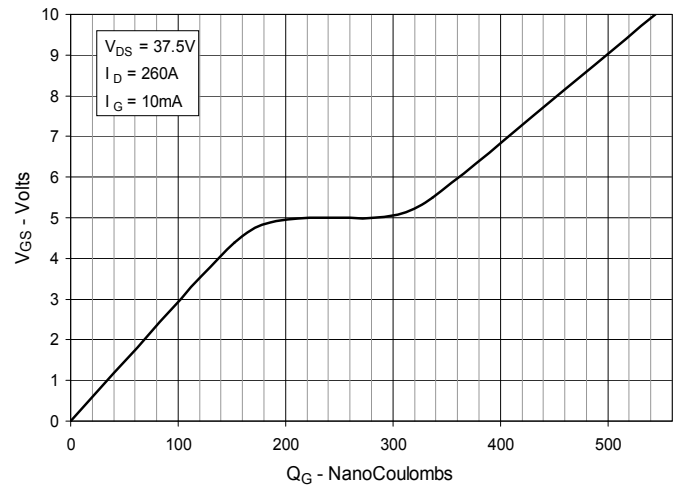


Fig. 11. Capacitance

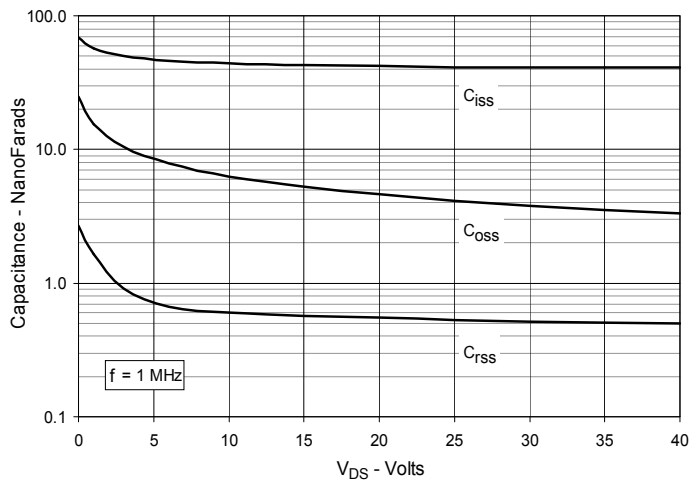


Fig. 12. Forward-Bias Safe Operating Area

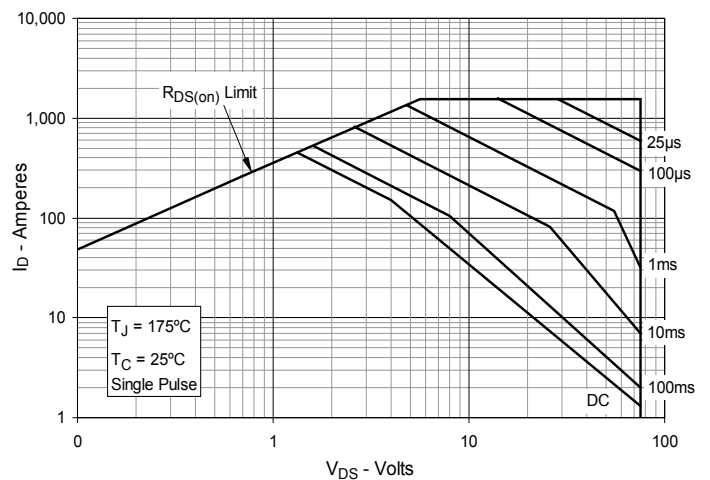
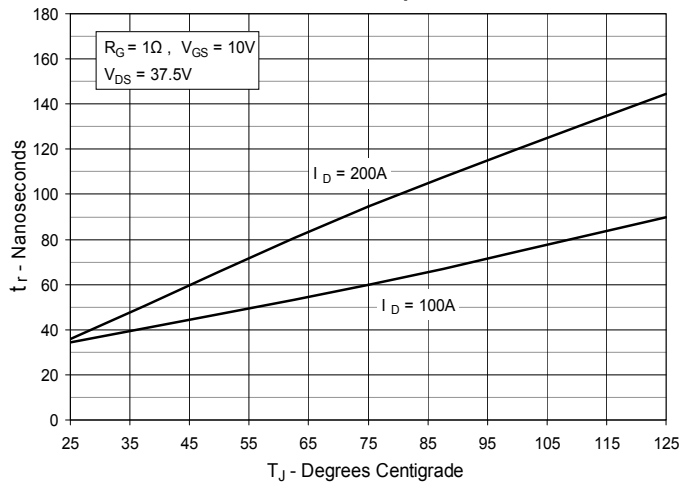
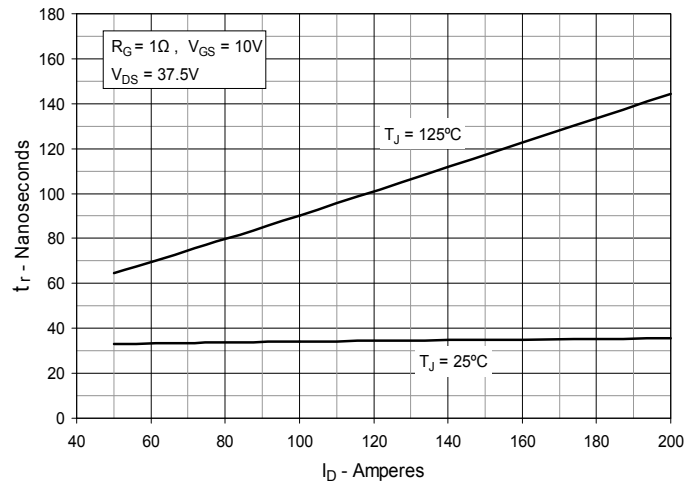
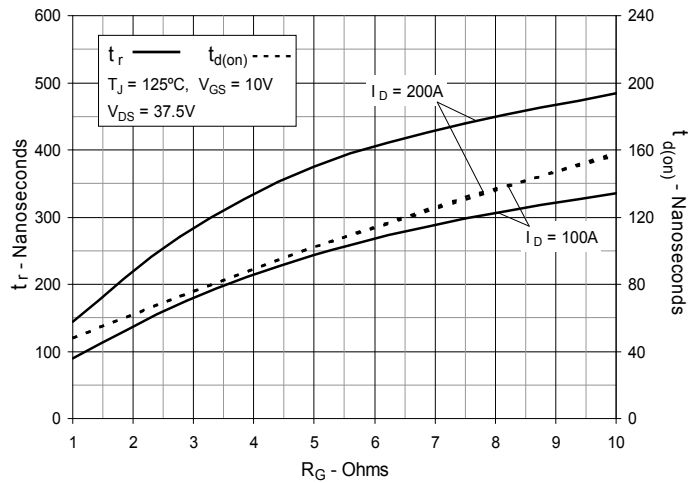
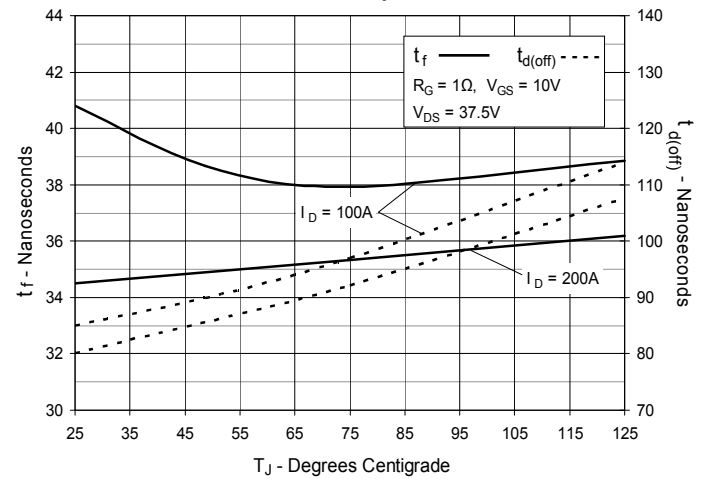
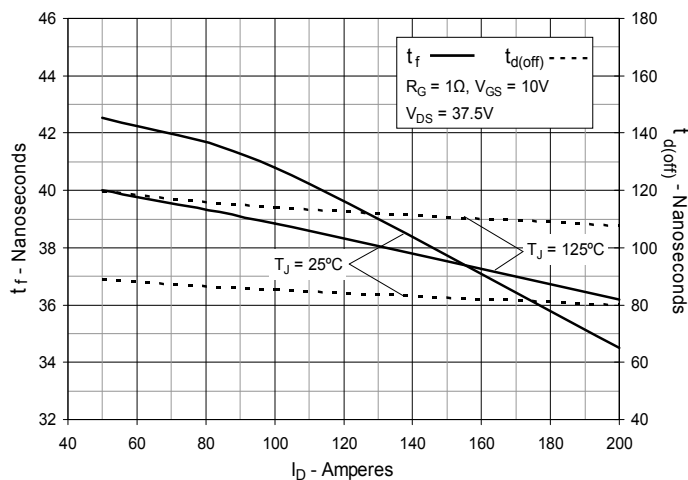
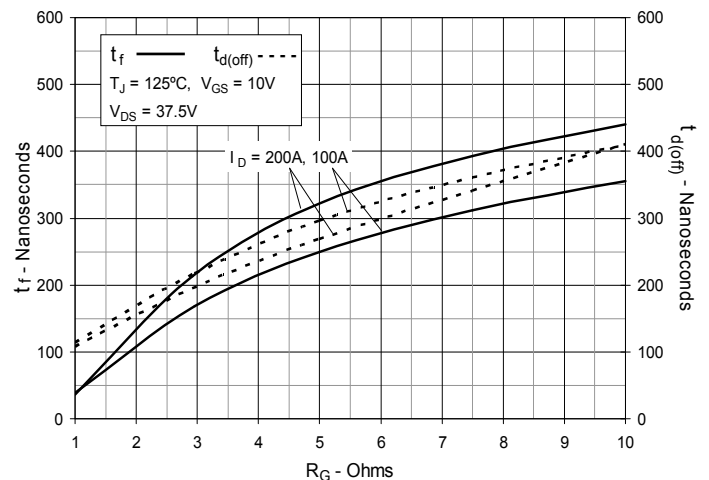


Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

Fig. 14. Resistive Turn-on Rise Time vs. Drain Current

Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

Fig. 17. Resistive Turn-off Switching Times vs. Drain Current

Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance


The graph shows the relationship between the pulse width and the normalized temperature rise. The y-axis, labeled $Z(t_h)_{JC} - ^\circ\text{C} / \text{W}$, is on a logarithmic scale from 0.001 to 0.400. The x-axis, labeled "Pulse Width - Seconds", is also on a logarithmic scale from 0.00001 to 10. The curve starts at a value of approximately 0.002 for a pulse width of 0.00001 seconds and increases, reaching a plateau of about 0.35 for pulse widths greater than 1 second.

Pulse Width - Seconds	$Z(t_h)_{JC} - ^\circ\text{C} / \text{W}$
0.00001	0.002
0.0001	0.006
0.001	0.02
0.01	0.07
0.1	0.2
1	0.32
10	0.35

The technical drawing illustrates a shaft-hub assembly with the following dimensions:

- Shaft Dimensions:**
 - Total length: 0.162 [4.11]
 - Left end diameter: 0.306 [7.77]
 - Right end diameter: 0.050 [1.27]
 - Central section diameter: 0.070 [1.78]
- Hub Dimensions:**
 - Inner bore diameter: 0.162 [4.11]
 - Outer diameter: 0.770 [19.56]
 - Hub thickness at ends: 0.346 [8.79]
- Assembly Details:**
 - Keyway width: 0.125 [3.18]
 - Key height: 0.006 [0.15]
 - Key depth: 0.049 [1.24]
 - Surface finish symbol: CO.050 [1.27]

LEADS – Full Silver plating.